#### 502575756 11/20/2013

# PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2621684

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
RYO ENDO	10/16/2013

# RECEIVING PARTY DATA

Name:	Renesas Mobile Corporation
Street Address:	6-2, Otemachi 2-chome, Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	100-0004

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14083629

# **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	XA-12472/T6957-20112US01
NAME OF SUBMITTER:	SOPHIA L. DAVIS
Signature:	/Sophia L. Davis/
Date:	11/20/2013
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**Total Attachments: 1** source=Assignment#page1.tif

> **PATENT** REEL: 031637 FRAME: 0992

# **ASSIGNMENT**

(誠識証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by <u>Renesas Mobile Corporation</u>, a corporation organized under the laws of Japan,

located at 6-2. Otemachi 2-chome. Chivoda-ku, Tokyo 100-0004, Japan,

receipt of which is hereby acknowledged, I do hereby sell and assign to said <u>Renesas Mobile Corporation</u>, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

# SEMICONDUCTOR DEVICE, RADIO COMMUNICATION TERMINAL, AND METHOD FOR CONTROLLING SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Mobile Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner for Patents to issue said Letters Patent to said Renesas Mobile Corporation.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)	Date Signed
(発明者フルネームサイン)	(署名日)

Ryo ENĐO		
1)	October 16.	2013
Ryo ENDO	· · · · · · · · · · · · · · · · · · ·	

PATENT REEL: 031637 FRAME: 0993

**RECORDED: 11/20/2013**